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## CS30-MIPI Module Product Specification

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Date	Version	Description
December 3, 2023	V0.1	First Draft

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# 1、 Module Description

## **Product Description:**

The CS30-MIPI module consists of RX component with a resolution of 640\*480 and TX component operating in the 940nm wavelength, equipped with a ToF image sensor. Utilizing ToF technology, the module excels in capturing three-dimensional information about objects and spaces, showcasing remarkable features such as long-range capability and low power consumption. Additionally, the module employs a standard MIPI-CSI2 interface for the output of RAW data.

## **Product Features:**

- Full resolution (1280 x 960) with up to 60 frames per second of raw data.
- MIPI-CSI2 standard interface: 2 lanes (1.6 Gbps per lane).
- Output formats: RAW10, RAW12.
- Camera Control Interface (CCI) and I2C compatible, two-wire serial communication circuit up to 1MHz.

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## 2、 Technical Parameters

Technical Parameters	
Resolution	640*480/320*240
FOV	H100°xV75°
Measure Distance	0.1-5m, indoor
VCSEL Wavelength	940nm
Accuracy	0.1~0.5m: ±2.5cm; 0.5~5m: ±1% @ 90% reflectivity
Dimensions	Appendix 1 2D drawing
Date Transmission	RAW10
Powering Method	IOVDD_ToF(1.8V), VCSEL_3V3, VCC_3V3
Power Consumption	TBD
Operating System	Android, Windows, Linux, ROS
Operating Temperature	-10 ~ 50°C
Safety	Laser CLASS1

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### 3、 Storage Conditions

Conditions	Description	Min	Max	Unit
Storage Temperature		-15	60	°C
	Humidity	Temperature/RH: 40°C/90%		
Operating Temperature		-10	50	°C

### 4、 Module Cleaning Procedures

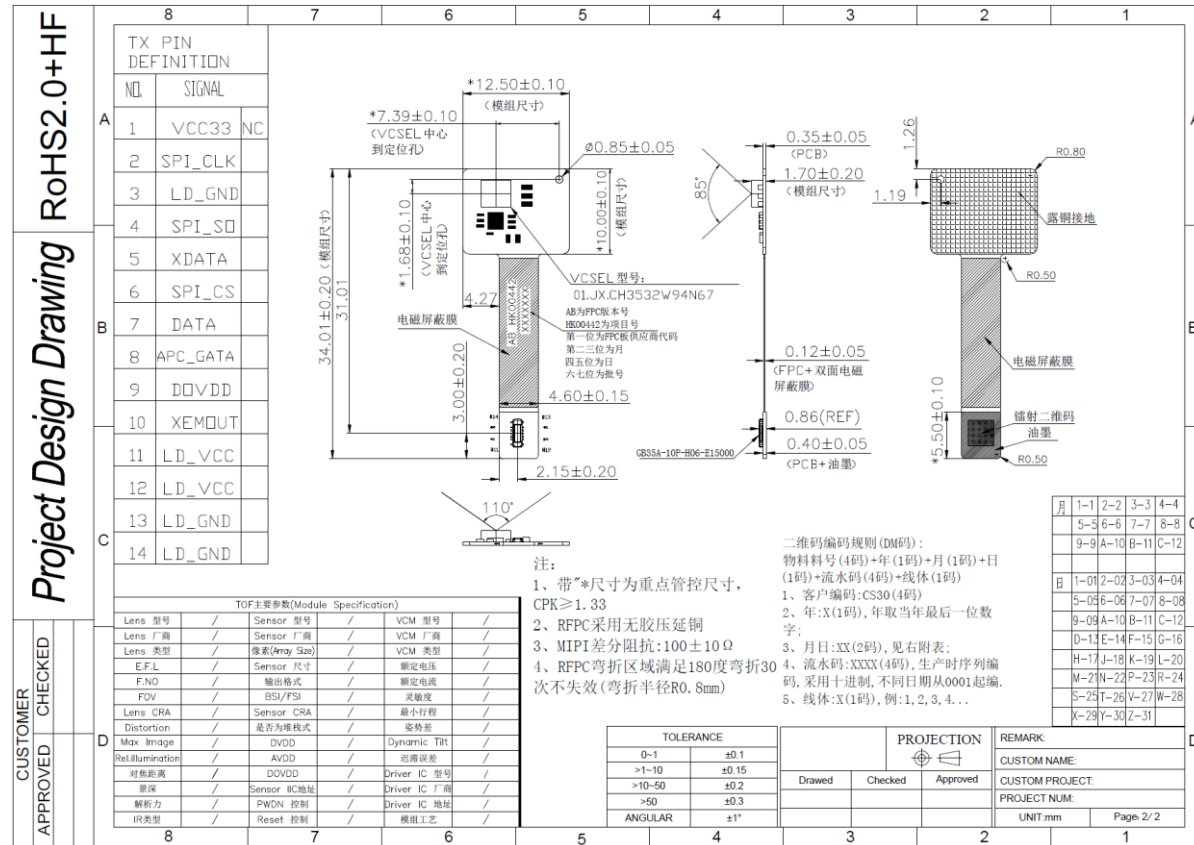
1. Avoid using any chemicals or water on the camera lens.
2. Use a lens blower brush to remove dust and dirt from the lens as thoroughly as possible.
3. Wipe with a dry, clean microfiber cloth.

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## 5. Disclaimer

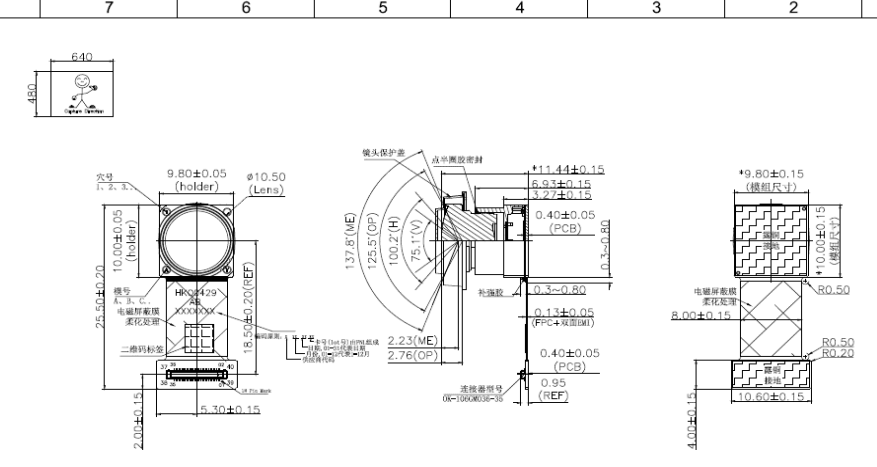
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# Appendix 1: Module Drawings



# Project Design Drawing RoHS2.0+HF

TOP PIN DEFINITION
1 AVDD
2 AVDD
3 AVDD
4 DGND
5 DGND
6 VSYNC_IN
7 MGP
8 DGND
9 MCN
10 HSET
11 DGND
12 DGND
13 MDP0
14 MDP1
15 MDN0
16 MDN1
17 DGND
18 DGND
19 DGND
20 SDA
21 GATA
22 SCL
23 XDATA
24 DGND
25 DGND
26 APC_GATE
27 SPL_CS
28 XEMOUT
29 SPL_S0
30 DGND
31 SPL_CLK
32 MCLK
33 DGND
34 DGND
35 VDDP_VDD
36 VDDP_VDD
37 DOVDD
38 DOVDD
39 AGND
40 AGND



- 注:
- 带\*标志的为重点尺寸,CPK≥1.33;
  - 胶板区域为两层无胶压延基材,系化处理;
  - MPI差分阻抗: 100±10Ω;
  - FPC弯折区域满足180度折弯30次不失效(弯折半径R=0.8mm);
  - 模组处于不工作状态时,建议关闭全部电源;
  - EEPROM:GT24P256C-2CSLI-TR, IIC地址: 0xA0(W)/0xA1(R);
  - CTP镜头: 龙;
  - Lens: 彩虹, L061D.

- 二维码编码规则 (DM码):
- 物料料号(4码)+年(1码)+月(1码)+日(1码)  
+流水码(5码)+线体(1码)  
(5码)
- 项目编码:SU01(4码)
  - 年:XX(1码),年取当年最后一位数字;
  - 月日:XX(2码),见右附表;
  - 流水码:XXXXX(5码),生产时序列编码,采用十进制,不同日期从00001起编。
  - 线体:X(1码),例:1,2,3,4...

月	1-1	2-2	3-3	4-4
5-5	6-6	7-7	8-8	
9-9	A-10	B-11	C-12	
B	1-01	2-02	3-03	4-04
	5-05	6-06	7-07	8-08
	9-09	A-10	B-11	C-12
	D-13	E-14	F-15	G-16
	H-17	J-18	K-19	L-20
	M-21	N-22	P-23	R-24
	S-25	T-26	V-27	W-28
	X-29	Y-30	Z-31	

CUSTOMER APPROVED CHECKED

TOP 主要参数(Must be Specified)			
Lens 型号	L061D	Sensor 型号	SMK330X
Lens 口径	φ10.50mm	Sensor 尺寸	1/3 inch
Lens 类型	4P	模组(Comp. Size)	640*480
EFL	2.534mm	Sensor 尺寸	1/3 inch
F#	1.2	模组尺寸	80*80
FOV	88°(H)/84°(V)	模组尺寸	80*80
Lens CRA	<23.7°	Sensor CRA	30°
Distortion	<1.0%	模组畸变	<1.0%
Max Image	8.1	DOV	1.05x
Resolution	>63.9%	AVDD	2.8V
功耗	300m	DOVDD	1.8V
接口	MIPI	Driver IC 型号	TI
接口	MIPI	Driver IC 型号	TI
接口	MIPI	Driver IC 型号	TI

TOLERANCE	
0-1	±0.1
>1-10	±0.15
>10-50	±0.2
>50	±0.3
ANGULAR	±1°

PROJECTION	
Checked	Approved

REMARK:
CUSTOM NAME:
CUSTOM PROJECT:
PROJECT NUM:
UNIT:mm Page: 2/2